

SEMITOP[®] 4

IGBT Module

SK75GD066T

Preliminary Data

Features

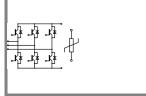
- One screw mounting module
- Fully compatible with SEMITOP[®]1,2,3
- Improved thermal performances
 by aluminium oxide substrate
- Trench IGBT technology
- CAL technology FWD
- Integrated NTC temperature sensor

Typical Applications

- Inverter up to 16 kVA
- Typ. motor power 7,5 kW

Absolute Maximum Ratings			= 25 °C, unless otherwise	25 °C, unless otherwise specified		
Symbol	Conditions		Values	Units		
IGBT						
V _{CES}	T _j = 25 °C		600	V		
I _C	T _j = 175 °C	T _s = 25 °C	83	A		
		T _s = 70 °C	67	А		
I _{CRM}	I _{CRM} = 2 x I _{Cnom}		150	А		
V _{GES}			± 20	V		
t _{psc}	V_{CC} = 360 V; $V_{GE} \le 20$ V; VCES < 600 V	T _j = 125 °C	6	μs		
Inverse	Diode					
I _F	T _j = 175 °C	T _s = 25 °C	92	A		
		T _s = 70 °C	73	А		
I _{FRM}	I _{FRM} = 2 x I _{Fnom}		150	А		
Module						
I _{t(RMS)}				А		
T _{vj}			-40 +175	°C		
T _{stg}			-40 +125	°C		
V _{isol}	AC, 1 min.		2500	V		

Characteristics T _s =		25 $^\circ\text{C},$ unless otherwise specified				
Symbol	Conditions		min.	typ.	max.	Units
IGBT						
V _{GE(th)}	V_{GE} = V_{CE} , I_C = 1,2 mA		5	5,8	6,5	V
I _{CES}	V_{GE} = 0 V, V_{CE} = V_{CES}	T _j = 25 °C			0,0038	mA
		T _j = 125 °C				mA
I _{GES}	V _{CE} = 0 V, V _{GE} = 20 V	,			600	nA
		T _j = 125 °C				nA
V _{CE0}		T _j = 25 °C		0,8	1,1	V
		T _j = 150 °C		0,7	1	V
r _{CE}	V _{GE} = 15 V	T _j = 25°C		8	10	mΩ
		T _j = 150°C		12,7	14	mΩ
V _{CE(sat)}	I _{Cnom} = 75 A, V _{GE} = 15 V			1,45	1,85	V
		T _j = 150°C _{chiplev.}		1,65	2,05	V
C _{ies}				4,7		nF
C _{oes}	V_{CE} = 25, V_{GE} = 0 V	f = 1 MHz		0,3		nF
C _{res}				0,145		nF
t _{d(on)}				95		ns
t _r	R_{Gon} = 16 Ω	V _{CC} = 300V		50		ns
E _{on}	di/dt = 2250 A/µs	I _C = 75A		3,1		mJ
t _{d(off)}	$R_{Goff} = 16 \Omega$	T _j = 150 °C		541		ns
t _f	di/dt = 2250 A/µs	V _{GE} = -7/+15 V		70		ns
E _{off}				2,8		mJ
R _{th(j-s)}	per IGBT			0,75		K/W



GD-T



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Symbol	Conditions	min. t	yp. max.	Units	
Inverse D	Diode				
V _F = V _{EC}	I _{Fnom} = 60 A; V _{GE} = 0 V	T _j = 25 °C _{chiplev.}	1	,35	V
		T _j = 150 °C _{chiplev.}	1	,31	V
V _{F0}		T _j = 25 °C			V
		T _j = 150 °C	0	,85	V
r _F		T _j = 25 °C			mΩ
		T _j = 150 °C	7	7,8	mΩ
I _{RRM}	I _F = 75 A	T _i = 150 °C		60	А
Q _{rr}	di/dt = 2250 A/µs			6	μC
E _{rr}	V _{CC} = 300V		0	,85	mJ
R _{th(j-s)D}	per diode			,2	K/W
M _s	to heat sink		2,5	2,75	Nm
w				60	g
Tempera	ture sensor				
R ₁₀₀	T _s = 100°C (R ₂₅ =5kΩ)		493	8±5%	Ω

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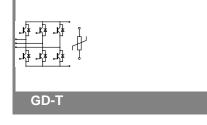
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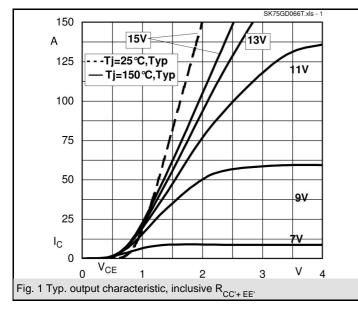
Typical Applications

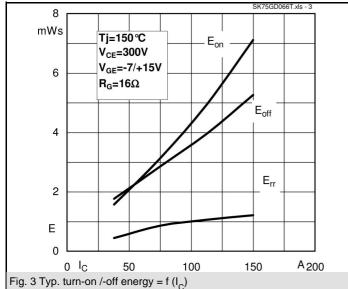
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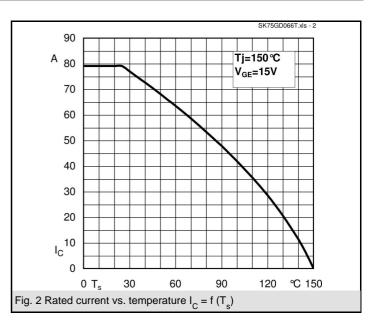
This is an electrostatic discharge sensitive device (ESDS), international standard IEC 60747-1, Chapter IX.

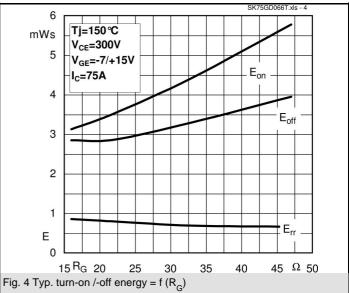
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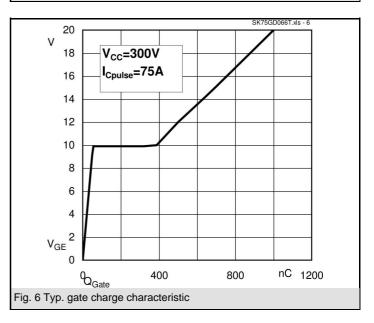


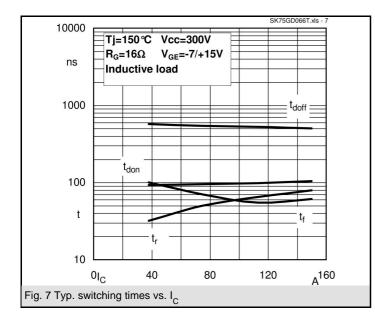


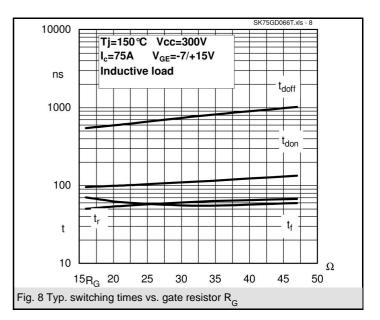


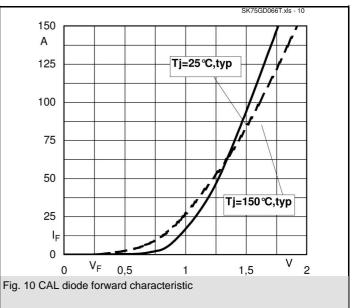












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